506349444 11/11/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
GANG WEI	11/09/2020
JING WEI	11/09/2020
JING YANG	11/09/2020

RECEIVING PARTY DATA

Name:	BEIJING NAURA MICROELECTRONICS EQUIPMENT CO., LTD.
Street Address:	NO.8 WENCHANG AVENUE
Internal Address:	BEIJING ECONOMIC-TECHNOLOGICAL DEVELOPMENT AREA
City:	BEIJING
State/Country:	CHINA
Postal Code:	100176

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17095278

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	RAINEE LOCKE
SIGNATURE:	/Rainee Locke/
DATE SIGNED:	11/11/2020

Total Attachments: 2

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PATENT 506349444 REEL: 054338 FRAME: 0394

ASSIGNMENT

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:

SYSTEM AND METHOD FOR PULSE MODULATION OF RADIO FREQUENCY POWER SUPPLY AND REACTION CHAMBER THEREOF

for which I/We executed an a	application for United	States Letters Paten	it concurrently herew	ith, as a
national stage in the United S	States of PCT Applic	ation No. PCT/CN20:	19/083470, or filed ar	application
for United States Letters Pate	ent on(A	pplication No); and	

WHEREAS, BEIJING NAURA MICROELECTRONICS EQUIPMENT CO., LTD., a limited company of P.R. China, whose post office address is No.8 Wenchang Avenue, Beijing Economic-Technological Development Area, Beijing 100176, P.R. China (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment:

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert here in parentheses (Application No. <u>17/095,278</u>, filed <u>Nov. 11, 2020</u>) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inve	entor 1:
Name:	Gang WEI
Signature:	丰(水)
Date:	7020.11.9
Inve	entor 2:
Name:	Jing WEI
Signature:	고류
Date:	7020.11.9
Inve	entor 3:
Name:	Jing YANG
Signature:	杨玄
Date:	2020. I/. T.